



2025 PXI Product Catalog



MVIT TECHNOLOGY A Subsidiary of SMTC Corporation



Introduction

MVIT TECHNOLOGY is engaged in the research, development, production, and sales of modular test and measurement instruments, microwave solid-state power amplifiers, and specialized test systems. Its current main products are modular instruments based on PXI, broadband power amplifiers, and semiconductor device testing systems. The company specializes in the field of RF chip testing, focusing on core technologies and product development such as RF broadband signal transmission and reception, high-speed, high-precision data acquisition, RF power amplification, and cloud-based testing control platforms. It provides independent and controllable comprehensive backend testing solutions for RF chips, modules, and microsystems in terminal devices.



The company adheres to a focused strategic development approach, upholding a business model of "interaction between industrial technology and market, creating long-term customer value" and a market model of "market-driven, technology-driven, product-driven." With technology research and development as its backbone and modern management as its means, it wholeheartedly provides stable and reliable products, first-class solutions, and high-quality services to its customers.





Awards





















2022.12

Completed strategic pre-Series A financing.



2022.08

The new research and development center in Chengdu is now operational.



2022.06

Completed angel round strategic financing.



2022.05

The \$GR RF broadband transceiver has been released.



2021.12

The CP filter testing software has been successfully delivered.



2021.11

Chengdu Research Center established, launching the development of the SGR series of RF broadband transceivers.



2021.10

Received the "500,000 + 500,000" policy award for leading incubating enterprises in Suzhou High-tech Zone.



2021.06

The first self-developed power amplifier product, PA-0560-47, has been finalized and delivered.



2021.02

Company Founded

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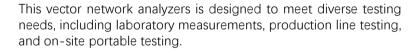
SNA3308

Vector Network Analyzer

Product Overview

The SNA3308 is a vector network analyzer (VNA) covering a frequency range of 10 MHz to 8.5 GHz. This model integrates 4 ports into a single device, making it suitable for RF performance test of cables, PCBs, filters, and more.

The SNA3308 features a PXIe standard 3U design, compressing the 4-channelVNA into just 2 slots. This design effectively saves space and reduces costs, making it ideal for highly integrated and automated test systems. It enhances test efficiency and simplifies scaling.





Technical Parameters

Vector Network Analyzer		
Model		SNA3308
Bus Interface		PXIe
Size		PXIe 2 slot
	Frequency Range	10MHz-8.5GHz
Frequency	Frequency Resolution	1Hz
	Full Frequency Accuracy	±5 ppm
	Power Range	-30 dBm ~ +5dBm
Power	Power Accuracy	±1.5 dB
	Power Resolution	0.05dB
Harmonic Distortion		-20dBc
Non-harmonic Spurious		-20dBc
Damage Level		>+26dBm
Noise Floor		-125dBm/Hz
Trace Noise Magnitude (If Bandwidth 1 kHz)		0.003 dB rms
Trace Noise Phase (If Bandwidth 1 kHz)		0.05 deg rms
Directivity		45dB
Source Match		40dB
Load Match		45dB



SGR3006/3008 Vector Signal Transceiver

Product Overview

The SGR series PXIe RF vector signal transceiver module integrates the functions of RF wideband vector signal reception and generation. With high integration and flexibility in usage, it supports PXIe system modular reconfigurable configurations.

The frequency range covers 300MHz to 8GHz, with a maximum instantaneous signal bandwidth of up to 1GHz. It features versatile general modulation and demodulation capabilities, as well as 3GPP standard communication modulation and demodulation functionalities. Optional hardware modulation and demodulation capabilities are available, providing the required performance to rapidly and efficiently address RF chip testing challenges both now and in the future.



Product Performance

300MHz~8GHz
1
1GHz
+30dBm
50Ω
AC

RF Output Performance		
Frequency Range	300MHz~8GHz	
Channel Qty	1	
Maximum Instantaneous Bandwidth	1GHz	
Maximum Output Power	+25dBm	
Output Impedance	50Ω	
Coupling Method	AC	
Output EVM	≤-40dB	

Main Function

- Analysis and Generation of Broadband Signals
- PXI Express interface
- API driver, Support for Application development.

- Rich User Example Library
- General Modulation and Demodulation Functionality: ASK,PSK,QAM
- Standard Communication Modulation and Demodulation Functionality: 5G NR, WiFi6e

Application Field







Radar and Satellite Communication



Instrumentation and Equipment Manufacturing



Automate Testing

Physical Characteristics

- 2 slots |3 U PXIe | Size: 210 mm × 40.3 mm × 128.65 mm
- Weight: <1.0kg
- Working Temperature: 0°C to 50°C

RF Wideband Signal Analysis Performance

Frequency Range

300MHz~8GHz

Storage Depth

1GSa (512MSa for I/Q Data)

Maximum Analysis Bandwidth

300MHz~350MHz	(Carrier Frequency -300) * 2 MHz
350MHz~760MHz	100MHz
760MHz~900MHz	200MHz
900MHz~8GHz	1000MHz

Trigger

Trigger Source External Trigger, Software Trigger, PXIe Backpanel Trigger

Triggering Modes Rising Edge, Falling Edge

Amplitude Range and Accuracy

Maximum Input Power +30dBm

300MHz~8GHz ±1.5dB

Display Average Noise Level (DANL)

Amplitude Accuracy of Continuous Wave Absolute

Center Frequency

300MHz~8GHz

(Test Conditions: Input terminal connected to a 50Ω load; normalized to a 1Hz bandwidth.)

Reference Level -30dBm

·

≤-145dBm/Hz

Typical Value

07 | PXI VST | 08

5.9GHz



Non-Harmonic Spurious		
Input Power 0 dBm	≤-60dBc @ 1GHz	
LO Leakage Power/Residual Power		
1GHz 3.5GHz 5.9GHz	≤-50dBm ≤-48dBm ≤-40dBm	
Third Order Intermodulation IIP3		
500MHz	30dBm (Reference Level -5dBm, Input Power-10dBm)	
1GHz	30dBm (Reference Level -5dBm, Input Power-10dBm)	
3.5GHz	30dBm (Reference Level -5dBm, Input Power-10dBm)	

30dBm (Reference Level -5dBm, Input Power-10dBm)

RF Wideband Signal Generation Performance

Frequency Range

300MHz~8GHz

Maximum Output Bandwidth

300MHz~350MHz 350MHz~760MHz 760MHz~900MHz 900MHz~8GHz (CF-300) *2 MHz 1000MHz 200MHz 1000MHz

Output Amplitude

Resolution 0.5dB

Output Amplitude Range From Noise Floor to +20dBm

Accuracy of Absolute Amplitude (Continuous Wave)

Absolute Amplitude Accuracy of Continuous Wave Typical Value

300MHz~8GHz ±1.5dB

Output Harmonics (Second Harmonic)

Output Power 0dBm ≤-55dBc Output Power -10dBm ≤-60dBc

Non-Harmonic Spurious

300MHz~8GHz ≤-60dBc

Phase Noise

Output Power +15dBm, CF=900MHz

 10kHz Offset
 ≤ -115dBc/Hz

 100kHz Offset
 ≤ -117dBc/Hz

 1MHz Offset
 ≤ -131dBc/Hz

Output Power +15dBm, CF=2400MHz

 10kHz Offset
 ≤ -105dBc/Hz

 100kHz Offset
 ≤ -101dBc/Hz

 1MHz Offset
 ≤ -127dBc/Hz

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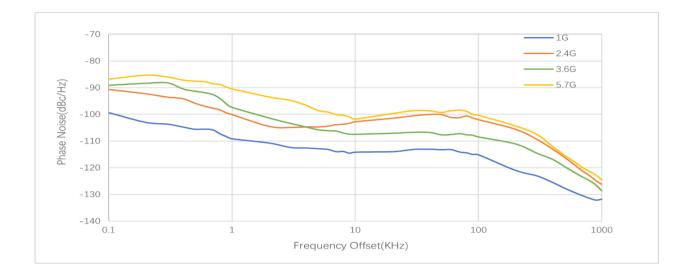
Phase Noise

Output Power +15dBm, CF=5700MHz

 10kHz Offset
 ≤ -102dBc/Hz

 100kHz Offset
 ≤ -100dBc/Hz

 1MHz Offset
 ≤ -125dBc/Hz



Error Vector Magnitude

EVM

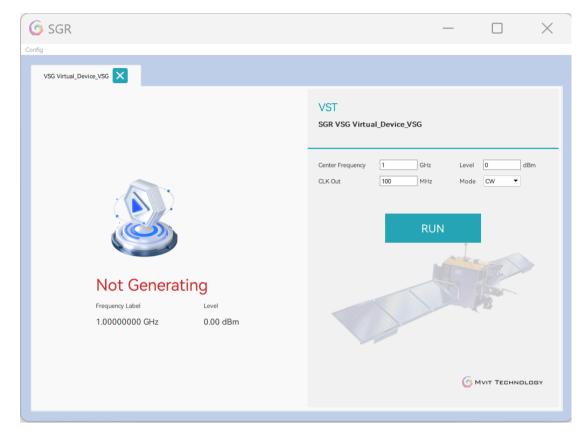
Center Frequency

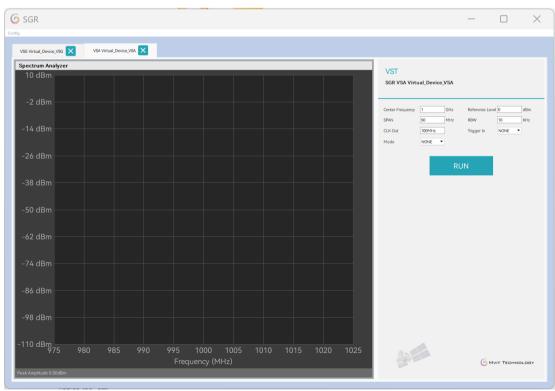
(Test conditions: 20MHz bandwidth, 64QAM modulation signal. Shaping filter: Root Raised Cosine, Roll-off factor 0.25. Carrier output power 0dBm.)

300MHz~8GHz

≤-40dB

Software Interface





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RSG3745 RF Signal Generator

Product Overview

The RSG3745 Analog Signal Generator is a high-performance RF signal source specifically designed for demanding R&D and production testing environments. With a wide frequency range spanning from 9kHz to 45GHz, it delivers exceptional output power, low phase noise, and fine frequency resolution down to 0.01Hz. The instrument features comprehensive analog modulation capabilities including AM, FM, and pulse modulation, supporting modulation depths up to 90% and a high on/off ratio exceeding 70dB. Built on a flexible PXle modular platform, the RSG3745 is ideal for integration into automated test systems, offering both scalability and reliability for advanced RF testing needs.



Product Specification

Product Model	RSG3745
Key Parameters	
Output Channels	1
Frequency Range (MHz)	9K-45G
Frequency Step (Hz)	0.01
Max RF Output Power (dBm)	10
Min RF Output Power (dBm)	-100
Power Step (dB)	0.01
Power Accuracy (dB)	≤±1 (with ALC on)
External Ref Input Freq (MHz)	10 (sync capable)
External Ref Input Power (dBm)	0~5
Reference Output Freq (MHz)	10/100
Reference Output Power (dBm)	0~5
Harmonic Distortion (dBc)	5±1dBm
Spurious Signals (dBc)	≤-30 (at 0dBm output)
SSB Phase Noise (dBc/Hz @10k)	≤-60 (at 0dBm output)
Power Supply	220V (50W)
Operating Temp (°C)	-10 ~ +45
Storage Temp (°C)	-40 ~ +70

Modulation	
Amplitude Modulation (AM)	
Modulation Depth	0%~90%
Modulation Frequency Response	10Hz~20KHz
Frequency Modulation (FM)	
Maximum Frequency Deviation	NX32MHz (nominal)
Modulation Frequency Response	10Hz~200KHz
Pulse Modulation (PM)	
On/Off Ratio	≥70dB
Pulse Width	100nS~50S
Pulse Period	100nS~50S

Interfaces		
RF Output	2.92, 50Ω	
Reference Input/Output	SMA-K	
FM/AM Input Interrace	SMA-K	
Program Control	PXIe	

Order Information

Model	Description
RSG3745	RF Signal Generator

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FEU3506/FED3506 6GHz Up/Down Converter

Product Overview

The FEU3506 up-converter delivers RF output spanning 400 MHz to 6000 MHz, while the FED3506 down-converter accepts RF input from 20 MHz to 6000 MHz. Both PXIe bus-interfaced units adopt a 3U module occupying two slots, enabling up-converter functionality control and debugging via PXIe. The solution provides PXI instrument drivers with C/C++ API support for parameter configuration, functional control, status monitoring, and reference clock configuration, and includes Windows 10 operating system drivers.



Technical Parameters

Product Model	FEU3506
Up-converter IF Input Specifications	
IF Input Frequency	30MHz ~ 110MHz
IF Bandwidth	80M
Max. IF Input Power	2Vpp
Up-converter RF Output Specifications	
RF Output Frequency	400MHz ~ 6GHz
Output Power	-70dBm ~ 13dBm
Gain Flatness	≤±0.75dB
Output P1dB	≥15dBm
Up-converter Frequency Conversion Param	neters
Link Gain	-70dB ~ 20dB ((at 15 dBm OP1dB))
Spurs	≤60dBc
LO Phase Noise	≤-100dBc/Hz@10kHz
Programmable Attenuation	0-90dB, Step: 1 dB

Product Model	FED3506	
Down-converter IF Output Specifications		
IF Output Frequency	70MHz	
IF Bandwidth	80M	
Max. IF Output Power	15dBm	
Gain Range	25±3 dB (Normal Mode) 40±3 dB (Low-noise Mode)	
IF Flatness	≤3dB (at 15 dBm OP1dB)	
Output P1dB	≥15dBm	
Down-converter RF Input Specifications		
RF Input Frequency	20MHz ~ 6GHz	
Max. Input Power	27dBm	
RF Flatness	≤±0.75dB	
Down-converter Frequency Conversion Parameters		
Input VSWR	< 2.5	
Spurious Suppression	≤50dB, Typ	
Programmable Attenuation	0-60dB, Step: 1 dB	
LO Phase Noise	≤-100dBc/Hz@10kHz	

Order Information

Model	Description
FEU3506	6GHz Up Converter
FED3506	6GHz Down Converter

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FED3526

26.5GHz Down Converter

Product Overview

FED3526 Down-Converter accepts RF input from 6 GHz to 26.5 GHz, featuring a PXIe bus interface in a 3U form factor that occupies a single slot. This unit enables down-converter functionality control and debugging via the PXIe bus, providing PXI instrument drivers with C/C++ APIs for parameter configuration, functional control, status monitoring, and reference clock configuration, along with Windows 10 OS drivers. The converter supports external LO signal injection to accommodate SISO and MIMO application scenarios. Its compact modular design maintains high performance while enhancing adaptability in highly integrated complex systems.



Technical Parameters

Product Model	FED3526
Down-converter IF Input Specifications	
IF Input Frequency	50MHz ~ 3GHz
IF Bandwidth	1500MHz
Max. IF Input Power	1500MHz
IF Flatness	≤3dB
Down-converter RF Input Specifications	
RF Input Frequency	-70dBm ~ 13dBm
Max. Input Power	≤±0.75dB
Down-converter Frequency Conversion Para	ameters
Input VSWR	< 2.2
Programmable Attenuation	0-30dB, Step: 1 dB
Gain	-40 dB to 40 dB (with Preamp Gain 20 dB)
Spurious Suppression	≤55dB, Typ
Noise Figure	+18dB
LO Phase Noise	≤-100dBc/Hz@10kHz
Converter Power Consumption	≤25W

Order Information

Model	Description
FED3526	26.5GHz Down Converter

FEU3543/FED3543 9KHz ~ 43GHz Up/Down Converter

Product Overview

The FEU3543 and FED3543 upconverters and downconverters support transmission and reception over a frequency range of 9 kHz to 43 GHz. They can be integrated with the SGR RF transceiver to build wideband signal generation and analysis systems covering an even broader frequency range. Additionally, the upconverters and downconverters support external LO signal input, making them suitable for applications requiring high phase synchronization, such as MIMO.



The converters feature a compact modular design that ensures high performance while providing better adaptability for highly integrated and complex applications.

Technical Parameters

Product Model	FED3543
Downconverter IF Output Signal	
IF Output Frequency	1875±500MHz
IF Output Power	0dBm
Gain Range	-35dB~25dB (Normal Mode) -15dB~45dB (Low Noise Mode)
Gain Flatness	0±1.5dB
Conversion Spurious	≤-60dBc
Image Rejection	≥60dB
Downconverter Input Signal Requirements	
Input Signal Frequency	9K~43000MHz
Input Signal Power	15dBm;(MAX)
Local Oscillator (LO)	
LO Phase Noise	≤-104dBc/Hz@10KHz
LO Step Size	10MHz
Reference Clock	
Reference Clock Frequency	10MHz
Output Power	9±1dBm
Frequency Stability	0.05ppm
Conversion Module Power Consumption	42W

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Product Model	FEU3543	
Upconverter IF Input Signal		
IF Input Frequency	1875±500MHZ	
IF Input Power	-5dBm	
Upconverter Output Signal		
Output Signal Frequency	9K~43000MHz	
Output Signal Power	15dBm;(MAX)	
Gain Range	-10dB~20dB	
Gain Flatness	0±2.5dB	
Conversion Spurious	≤-60dBc	
Image Rejection	≥60dB	
Conversion Local Oscillator (LO)		
LO Phase Noise	≤-104dBc/Hz@10KHz	
LO Step Size	10MHz	
Reference Clock		
Reference Clock Frequency	10MHz	
Output Power	9±1dBm	
Frequency Stability	0.05ppm	
Conversion Module Power Consumption	42W	

Order Information

Model	Description
FED3543	9KHz ~ 43GHz Down Converter
FEU3543	9KHz ~ 43GHz Up Converter

SDA Series

High Speed Data Storage Module

Product Overview

The SDA high-speed data storage module provides large-capacity, high-throughput storage in a single PXle slot. It integrates four M.2 solid-state drives (SSDs), making it ideal for data streaming applications that require reliable, sustained data throughput, such as high-speed signal intelligence, RF signal recording and playback, and multi-sensor fusion data acquisition systems.

The SDA series is based on software RAID, offering high-speed, large-capacity data storage at a lower cost within a compact PXIe chassis. It's ideal for PXIe systems requiring high-speed read/write capabilities, high-speed data recording, transferring data between multiple test setups, or expanding the storage capacity of PXIe system controllers. This module supports software-based striping, simple, or spanned RAID arrays, allowing the combination of multiple storage devices into several logical units.



Key Feature

- Standard PXIe single-slot card structure, supporting up to PCIe 3.0x8 bus with a maximum data throughput rate of >5GB/s.
- Available in 4TB, 8TB, and 16TB capacities (equipped with four NVMe M.2 SSDs).
- Compatible with PCle 3.0/2.0/1.0, but installing it in a lower-speed PXle slot will reduce the maximum read/write rate.
- Supports Windows 7/8/10 operating systems with full-speed power consumption of less than 30W, and operating temperature range of 0~55°C.

Order Information

Model	Description
SDA8304	4TB High Speed Data Storage Module
SDA8308	8TB High Speed Data Storage Module
SDA8316	16TB High Speed Data Storage Module

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SDS4025

High Speed Oscilloscope/Digitizer

Product Overview

The SDS4025 is used for high-speed acquisition of waveform data for broadband signals. It features dual-channel signal acquisition and storage, multiple acquisition and triggering modes, complex signal calculation and processing, time-domain analysis of signal waveforms, cursor measurement, onboard instrument setting storage, automatic calibration and tracking, plug-and-play functionality, and compliance with IVI driver standards.



Technical Parameters

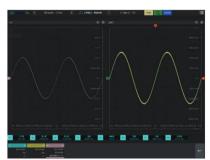
Product Model	SDS4025
Signal Input Channels	2
Real-time Sampling Rate	2.5GSa/s per channel
Vertical Resolution	10bit
Maximum Input Voltage	5Vpp@50Ω, 42Vpp@1MΩ
Onboard Memory	2GB
Bandwidth (-3dB)	500MHz@50Ω, 300MHz@1MΩ
Rise Time	750ps@50Ω, 1.4ns@1MΩ
Range	50Ω: 50mVpp~5Vpp; 1MΩ: 50mVpp~42Vpp
DC Gain Accuracy	\leq \pm [2% × reading - offset + 1.4% × offset + 0.6% full scale) + 600 μ V] (calibration temperature \pm 3°C)
Input Impedance	$1M\Omega\pm0.75\% 15pF\pm2.5 pF, 50\Omega\pm1.5\%$
Coupling Mode	DC/AC
Channel Isolation	50Ω: -60dB@ (DC~100MHz) , -45dB@ (100MHz~500MHz) 1MΩ (0.05V~10V full scale) : -55dB@ (DC~100MHz) , -45dB@ (100MHz~300MHz)
Connector	BNC
Trigger Source	CH0, CH1, external trigger, software
Trigger Type	Edge, Pulse Width
Trigger Holdoff	0 ~ 10s
Time Measurement Resolution	4ps
Trigger Accuracy	6%FS≤10MHz
Trigger Source	CH0, CH1, external trigger
Bus Connection	PXIe
Structural Form	3U, PXIe single slot
Width × Height × Depth	20 mm × 131 mm × 214mm
Weight	≤800g
Maximum Power Consumption	≤40W
Environmental Adaptability	Operating temperature: $10\sim40^{\circ}$ C; Operating relative humidity: $\leq 60\%$ RH; Storage temperature: $-30\sim50$ C; Storage relative humidity: $\leq 60\%$ RH; Altitude: 2 km

Software Interface

• The accompanying oscilloscope software provides functions for data acquisition, capture, display, and measurement. It offers standard IVI driver functions, supporting secondary development applications.







Order Information

Model	Description
SDS4025	High Speed Oscilloscope/Digitizer

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MVIT TECHNOLOGY

DMM4365 Digital Multi-Meter

Product Overview

The DMM4365 is a 6½-digit digital multimeter module based on the PXI bus. It can perform measurements of AC/DC voltage, AC/DC current, 2-wire resistance, 4-wire resistance, frequency, and other signal types. It features automatic range selection and overload protection. When paired with matrix modules (2-wire, 4-wire) or multiplexer modules, a single DMM4365 can measure signals such as current, resistance, and frequency across multiple channels.



Technical Parameters

Main Function

- AC/DC voltage measurement
- AC/DC current measurement
- 2-wire/4-wire resistance measurement
- Frequency measurement

- Automatic range selection
- Overload protection
- Low temperature coefficient and high longterm stability

Product Model	DMM4365			
Resolution	6½-bit			
Measurement Mode	DC/AC voltage, DC/AC current, 2-wire resistance, 4-wire resistance, frequency, period			
V I: M	DC -300V~300V			
Voltage Measurement Range	AC 300V RMS			
AC/DC Voltage Range	200mV, 2V, 20V, 200V, 300V, Auto			
	DC -3A~3A			
Current Measurement Range	AC 3A RMS			
DC Current Range	2mA, 20mA, 200mA, 2A, 3A			
AC Current Range	20mA, 200mA, 2A, 3A			
Resistance Measurement Range	≤100MΩ			
Frequency Measurement Range	3Hz~1.5MHz			
Trigger Method	Auto trigger (software trigger), upgradable to bus trigger			
Maximum Non-Destructive Voltage	350VRMS			

Accuracy

DC Measurements

Function	Level	24 Hour 90 Days		1 Year	
	100mv	0.100+0.041	0.104+0.046	0.107+0.046	
	1V	0.031+0.001	0.035+0.006	0.038+0.006	
DC Voltage	10V	0.036+0.013	0.040+0.018	0.043+0.018	
	100V	0.035+0.001	0.039+0.006	0.042+0.006	
	300V	0.002+0.033	0.006+0.038	0.009+0.038	
	100Ω	0.080+0.022	0.084+0.027	0.087+0.027	
	1ΚΩ	0.011+0.009	0.015+0.014	0.018+0.014	
	10ΚΩ	0.021+0.004	0.025+0.009	0.028+0.009	
Resistance	100ΚΩ	0.002+0.001	0.006+0.006	0.009+0.006	
	1ΜΩ	0.020+0.001	0.024+0.006	0.027+0.006	
	10ΜΩ	0.040+0.004	0.044+0.009	0.047+0.009	
	100ΜΩ	0.400+0.100	0.404+0.105	0.407+0.105	
	1mA	0.080+0.148	0.084+0.153	0.087+0.153	
	10mA	0.050+0.018	0.054+0.023	0.057+0.023	
DC Current	100mA	0.080+0.045	0.084+0.050	0.087+0.050	
	1A	0.030+0.025	0.034+0.030	0.037+0.030	
	3A	0.040+0.051	0.044+0.056	0.047+0.056	
	Accuracy	specification: ±(% of reading +	% of range)		

AC Measurements

Function	Frequency	Level	24 Hours	90 Days	1 Year
	30Hz -	100mV	0.040+0.390	0.044+0.395	0.047+0.395
		1V	0.260+0.197	0.261+0.197	0.263+0.197
		10V	0.150+0.740	0.154+0.745	0.157+0.745
		100V	0.010+0.209	0.014+0.214	0.017+0.214
AC Voltage	400Hz	100mV	0.240+0.032	0.244+0.037	0.247+0.037
		1V	0.040+0.167	0.044+0.172	0.047+0.172
		10V	0.020+0.186	0.024+0.191	0.027+0.191
		100V	0.010+0.200	0.014+0.205	0.017+0.205
		300V	0.050+0.027	0.054+0.032	0.057+0.032
		10mA	0.080+0.150	0.084+0.155	0.087+0.155
AC Current		100mA	0.150+0.120	0.154+0.125	0.157+0.125
		1A	0.060+0.007	0.064+0.012	0.067+0.012
		3A	0.070+0.054	0.074+0.059	0.077+0.059
	Acc	curacy specification: ±(% of reading + % of range)		

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Physical Characteristics

- 4mm banana socket connectors x 4
- Multimeter probe jacks x 4
- Trigger socket x 1
- Operating temperature: -10°C to 50°C

- Dimensions: 3U single-slot
- Storage temperature: -40°C to 70°C
- Humidity: 10% to 90% (non-condensing)

PCI Interface Characteristics

- Compliant with PICMG 2.0, R3.0
- 32-bit, 33MHz PCI interface
- Compatible with 3.3V/5V PCI I/O levels

Software Interface

The DMM4365 offers an interactive software panel enabling fast measurements and meeting various application requirements.



SPU Series

Precision Parametric Measurement Unit

Product Overview

The SPU Series High-Performance Digital Channel Instrument is a single-slot PXI digital pattern instrument supporting up to 64M vectors per second. It features a vector-based digital channel board for pin mapping, specifications, voltage levels, and pattern control. Each digital channel's output voltage can be flexibly adjusted between -1.5V and +6.5V, providing versatile testing capabilities for various types of IC chips. Each system can support up to 8 SPU5100 boards, offering a maximum of 256 channels to meet the requirements of most complex digital signal tests. The instrument supports data rates up to 200 Mbit/s, clock frequencies over 100 MHz, and test cycle times under 10 ns.



Product Performance

Product Model	SPU6151
Channel Performance per Instrument	
Number of Channels	32
System Channel Count	256
Channel Voltage Range	-1.5V to 6.5V
Timing Specifications	
Vector Memory Depth	64M
Maximum Data Transfer Rate	200Mbps
Maximum Clock Rate	200MHz
Embedded Protocols	MIPI, SPI, UART, IIC
Format	
Data Format	NRZ, RZ, RO /NR
Data Edges	ON, DATA, RETURN, OFF, STROBEA, STROBEB
Driver/Comparator/Load Voltage Clamping	
Channel High Clamp Range	-1V to 7V
Channel Low Clamp Range	-2V to 6V

Order Information

Model	Description
SPU6151	High-Performance Digital Channel Instrument, supporting 32 channels with a maximum data rate of 200 Mb/s.

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SMU Series Source Measure Unit

Product Overview

The PXI Precision Source Measurement Unit (SMU) can simultaneously output and measure voltage and current. It supports traditional SMU SCPI commands, making the migration of test code quick and easy. The device is compatible with PXIe chassis from major manufacturers and supports multi-card synchronization for high-channel-density testing. It is easy to integrate into production test systems, improving testing efficiency and reducing costs.



Technical Parameters

Item	SMU4221	SMU4211	SMU4212	SMU4213	SMU4216	SMU4234
Number of Channels	4	1	1	1	1	12
Voltage Range	±30V	±60V	±200V	±200V	±200V	±4.5V
Voltage Sensitivity	500uV	100nV	100nV	100nV	100nV	1uV
Current Range	±500mA	±3A	±1A	±1A	±1A	±10mA
Current Sensitivity	100pA	100fA	10fA	100fA	1fA	10pA
Pulse	±500mA	±10A	±3A	±3A	±3A	±10mA
Maximum Absorbed Power	3W/CH 6W - 4CHs	12W	12W	12W	12W	NA
Maximum DC Supply Power	3W/CH 6W - 4CHs	20W	20W	20W	20W	NA
Maximum Sampling Rate	500KS/s	1MS/s	1MS/s	1MS/s	1MS/s	1MS/s

Order Information

Model	Description
SMU4221	4-Channel PXIe Precision Source Measure Unit
SMU4211	Single-Channel PXIe Precision Source Measure Unit, Pulse Source
SMU4212	Single-Channel PXIe Precision Source Measure Unit, Pulse Source
SMU4213	Single-Channel PXIe Precision Source Measure Unit, Pulse Source
SMU4234	12-Channel PXIe Precision Source Measure Unit
SMU4216	Single-Channel PXIe Precision Source Measure Unit

ARINC429

Bus Transceiver Module

Product Overview

The ARINC429 bus transceiver module adopts a standard PXI 3U modular design and provides ARINC429 bus data transmission and reception capabilities, fully compliant with ARINC429 bus protocol standards. Its flexible design allows for configurations of 1, 4, 8, or 16 channels to meet the needs of various application scenarios. Additionally, the module bridges multiple bus transceiver modules from the host computer via an optical-to-serial interface, enabling expansion of multiple bus interfaces with additional discrete signal acquisition. It supports serial communication rates from 10 kbps to 30 Mbps, with adjustable rates to accommodate diverse communication requirements, and is widely used in avionics systems.



Product Features

- Number of transmit/receive channels: 1/4/8/16
- Independent buffering
- Each channel's baud rate, parity, and other parameters are individually configurable
- Supported data formats: 32-bit, 25-bit
- Configurable transmit/receive baud rates: 10 kbps, 12.5 kbps, 50 kbps, 100 kbps
- Parity options: odd, even, or none
- Built-in self-loopback test function

Product Specifications

Product Model	ARINC429
1	Communication interface: J30J-15KWJ-J
Interfaces	System communication interface: 3U PXIe (XJ3 and XJ4, PCIe 2.0 X1/X4)
Operating Temperature	-40°C to +75°C (industrial grade)
Storage Temperature	-50 °C to +80 °C
Humidity	5% to 95%
Power Consumption	≤6W
Weight	≤0.5Kg

27 | PXI SMU

MIL-1394B

Bus Communication Card

Product Overview

The MIL-1394B communication card is a 3U PXIe board compliant with the MIL-1394B (AS5643) protocol specification. At the physical layer, it supports the IEEE-1394b standard, offering selectable data rates of 100 Mbps, 200 Mbps, and 400 Mbps. The card supports 1–2 nodes, with each node providing three independent ports. It accommodates both periodic and event-driven messages and features CC (Cycle Controller) and RN (Redundant Node) modes, meeting communication requirements for various scenarios.

Designed primarily for simulation and testing of MIL-1394B (AS5643) bus protocols, the card also provides Windows-based host software and API driver functions to facilitate further development and application.



Product Features

- Supports periodic and event-driven messages
- Configurable fault injection for CRC errors, undersized frames, oversized frames, and other error simulations
- Equipped with transmit and receive buffers, hardware buffer capacity: ≥256 MB
- Supports time-stamping with resolution better than 1 μs
- Supports dual operation modes: CC (Cycle Controller) and RN (Redundant Node)
- Supports real-time modification of STOF packets and messages
- Programmable STOF offset, supporting fine message offset adjustments

Product Specifications

Product Model	MIL-1394B
Bus Interfaces	System communication interface: 3U PXIe (XJ3 and XJ4, PCIe 2.0 X1/X4)
bus interfaces	MIL-1394B interface: HJ30J-36ZKW-J (2 nodes, each with 3 ports)
Physical Dimensions	160 mm × 100 mm × 4 HP, equipped with 3U ejector handle
Operating Temperature	-40 °C to +75 °C (industrial grade)
Storage Temperature	-50°C to +80°C
Humidity	5% ~ 95%
Power Consumption	≤6W
Weight	≤0.5Kg

MIL-STD-1553B

Bus Communication Card

Product Overview

The MIL-STD-1553B communication card is a standard 3U PXIe board designed in compliance with the MIL-STD-1553B protocol and GJB289A-97 bus standards. It features a 4-channel dual-redundant design, with each channel configurable as BC (Bus Controller), RT (Remote Terminal), or RT&BM (Remote Terminal and Bus Monitor). The output utilizes transformer coupling, and the bus communication rate supports up to 1 Mbps. Additionally, the card provides Windows-based host software and API driver functions, offering strong support for related communication tasks and meeting diverse user requirements.



Product Features

- Number of channels: 4, each channel with dual-redundant A and B sub-channels
- Supports both periodic and event-driven messages
- Supports multiple communication types: BC→RT, RT→BC, RT→RT
- Equipped with transmit and receive buffers, hardware buffer capacity: ≥256 MB
- Supports time-stamping with resolution better than 1 μs
- Supports Bus Controller (BC), Remote Terminal (RT), and Bus Monitor (BM) modes
- Configurable frame and message intervals
- Supports error injection

Product Specifications

Product Model	MIL-STD-1553B
Due leterforce	System communication interface: 3U PXIe (XJ3 and XJ4, PCIe 2.0 X1/X4)
Bus Interfaces	1553B interface: J30J-25ZKW-J (4 channels, each with dual-redundant A and B sub-channels)
Physical Dimensions	160 mm × 100 mm × 4 HP, equipped with 3U ejector handle
Operating Temperature	-40 °C to +75 °C (industrial grade)
Storage Temperature	-50°C to +80°C
Humidity	5% ~ 95%
Power Consumption	≤6W
Weight	≤0.5Kg

29 | PXI ACM



High Performance PXI Chassis Series



Product Features

- Multi-slot configurations: 4/6/9/18/21 slot options
- Exceptional bandwidth: Up to 24 GB/s system bandwidth with 8 GB/s per slot
- Hybrid slot architecture: Backward-compatible with PXI, PXI Express, Compact PCI, and Compact PCI Express modules
- Point-to-point streaming capability: Enables direct module-to-module data transfer
- 10 MHz system reference clock, PXI Trigger Bus, Star Trigger and Low-jitter 100 MHz internal reference clock
- Optimized thermal management: 102 W per-slot cooling capacity

Product Specifications

Туре	Model	Bus Type	Total Slots	Hybrid Slots	Max. System Bandwidth	Timing Slot	Per-slot Cooling Capacity
	PXC1191	PXIe Gen3	18	6	24GB/s	√	50W/82W
-	PXC1194	PXIe Gen3	21	8	24GB/s	√	102W
High- performance	PXC1182	PXIe Gen2	18	10	8GB/s	√	38W
-	PXC1192T	Thunderbolt™3 PXI Express	4	4	40Gb/s Thunderbolt™ 3	_	58W/38W
C	PXC1180	PXIe Gen2	9	7	8GB/s	√	30W
Compact –	PXC1181	PXIe Gen2	6	5	8GB/s	√	38W

Embedded Technology PXI Controller Series

Product Features

- High-performance Intel processors
- Maximized system bandwidth: 16 GB/s aggregate throughput
- Multi-OS support: Windows 11, Windows 10, and Linux
- Flexible I/O peripheral interfaces facilitating external instrument control



Product Specifications

Product	oduct Bus Processor Max. Systen		Max. System	Hard Drive Display	Display	I/O Type			
Model	Type	FIOCESSOI	Bandwidth	Bandwidth		Ethernet	USB	GPIB	
PXC2291	PXIe Gen3	11th Gen Intel Xeon® W-11865MRE (2.6/4.7GHz)	16GB/s	512GB SSD	2	2	4 – USB2.0 2 – USB3.0	1	
PXC2297	PXIe Gen3	11th Gen Intel Core™ i7-11850HE (2.6/4.7GHz)	16GB/s	512GB SSD	2	2	4 – USB2.0 2 – USB3.0	1	
PXC2295	PXIe Gen3	11th Gen Intel Core™ i5-11500HE (2.6/4.5GHz)	16GB/s	512GB SSD	2	2	4 – USB2.0 2 – USB3.0	1	
PXC2293	PXIe Gen3	11th Gen Intel Core™ i3-11100HE (2.4/4.4GHz)	16GB/s	512GB SSD	2	2	4 – USB2.0 2 – USB3.0	1	
PXC2190	PXIe Gen3	7th Gen Intel Core™ i7-7820EQ 3.0GHz (Turbo 3.7GHz)	16GB/s	240GB HDD/500GB SSD	2	2	4 – USB2.0 2 – USB3.0	1	

31 | PXI Chassis

SNAEP108 VNA Calibration Module

Product Overview

The SNAEP108 high-precision electronic calibration module delivers rapid, efficient, and accurate performance. It interfaces with vector network analyzers via a universal USB Type-C cable, automatically configuring with the instrument software for one-button SOLT calibration. Compatibility with Keysight and Rohde & Schwarz network analyzer series is achieved using dedicated utilities.



Product Specifications

Parameter	Specification
Max. Input Power Level	15dBm
Max. DC Voltage	6 V
Operating Temperature Range	-10°C~+45°C
Dimensions	60mm×75mm×15mm
Weight	Approx. 150 g
Connector Type	SMA

Specification

4-Port SMA Connector Specification				
Frequency Range	10MHz~8500MHz			
Directionality	44			
Source Match	40			
Load Match	44			
Transmission Tracking	0.1			
Reflection Tracking	0.05			

All above test results were measured under an ambient temperature of 26°C, with the Vector Network Analyzer (VNA) ports set to -10 dBm output power after a 1-hour warm-up period. The VNA Calibration Module has a maximum power handling capability of 15 dBm.

Order Information

Model	Description
SNAEP108	VNA Calibration Module

33 I VNA-CAL I 34



All-in-one Sorting and Testing Machine

Product Overview

This solution is mainly used in the backend production of semiconductor chips. It can fully automate various functions such as chip appearance and size inspection, electrical parameter testing, laser marking, mark inspection, classification, sorting and storage, and final taping and packaging output. With the help of independently developed host computer software, it offers industry-leading testing speed and precision.



System Overview

System features

- Industry-leading UPH
- Save floor space
- Flexible compatibility and scalability
- Fast equipment deployment and high cos performance
- Suitable for RF microwave devices such as SAW, LTCC, Switch

System configuration

Testing Cabinet Mvit STP8000

• VNA Mvit/Keysight/Rohde & Schwarz/3rd party

• Sorter HT sorter/3rd party sorter

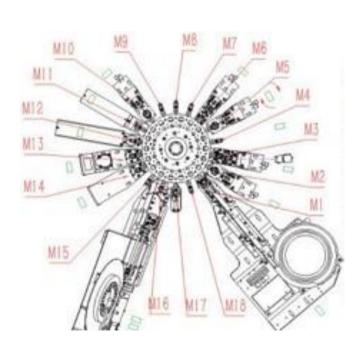
• Customization Supported

Technical Specifications

Sorting Machine		
CSP Type	DFN/QFN/SOT/SOD	
Chip Size	0.4*0.4mm→1*1mm	
UPH Max	≥45K/H	
Test Station QTY	2~4	
Package Sealing	Heat-Sealing Packaging	
Taping Reel size	7~13"	
Power supply	220VAc 50Hz	
Compressed air source	essed air source 0.45~0.8Mpa&-40~-80Kpa	
Sealing temperature	70°C ~ 250°C	
Sealing time	20ms~500ms	



Sorting Machine		
Sealing pressure	0.2~0.5Mpa	
Precise positioning	<5arcsec	
MTBA	≥1H	
MTBF	≥168H	
Feeding method	Vibratory Feeder	
Discharging method	Taping	
PolarityTesting	Vision test station	
Rotation/Steering	Positioning error≤10arcsec	
Sub-Tray	Positioning accuracy≤5arcsec	
Vision1	Orientation	
Vision2	Print/Mark	
Vision3	Pins	
Vision4	Taping	
Test method	Press testing	
Sorting device	Bin bucket or bin tube	
Human-machine Interface	Touch screen/keyboard-mouse	
MTTA	≤3 minutes	



Main Turret Operation Flow

M1 Product Feeding Mechanism

M2 Positioning and Alignment

M3 Sub-Turret Vision Inspection

M4 NC

M5 Rotary Positioning #1

M6 Testing

M7 NC

M8 NC

M9 NC

M10 Rotary Positioning #2

M11 2-Second Side Vision Inspection

M12 Bottom Vision Inspection

M13 Classification (1:8)

M14 Good Product Conveyor M15 NC

M16 Tape and Reel Packaging Mechanism

M17 Purge Bin

M18 NC

Main Turret: Driven by an imported DD motor and drive unit, equipped with 18 suction cups. (Can be upgraded to 4/36 suction cups)

STP8000L

High Speed Cable Testing System

Product Overview

The STP8000L is a high-speed cable test system. It supports mainstream high-speed digital standard protocols, including PCle Gen4/Gen5 1X-16X, Mini SAS HD / Slimline SAS, SFP / SFP+ / SFP28 / SFP56, QSFP+ / QSFP28 / QSFP56 / QSFP-DD / OSFP, USB3.0 / USB4.0 / TBT3.0 / TBT4.0 / HDMI / DP, and high-speed differential pairs.

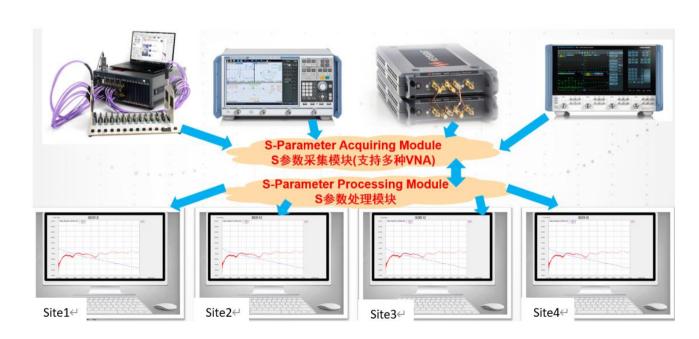
This system can be used for rapid detection in production lines. With hardware and software options, the system can also help to identify problems in R&D stage, such as issues caused by adapters, structural, cables, and other factors.



System Components

The STP8000L is a high-speed cable test system. It supports mainstream high-speed digital standard protocols, including PCle Gen4/Gen5 1X-16X, Mini SAS HD / Slimline SAS, SFP / SFP+ / SFP28 / SFP56, QSFP+ / QSFP28 / QSFP56 / QSFP-DD / OSFP, USB3.0 / USB4.0 / TBT3.0 / TBT4.0 / HDMI / DP, and high-speed differential pairs.

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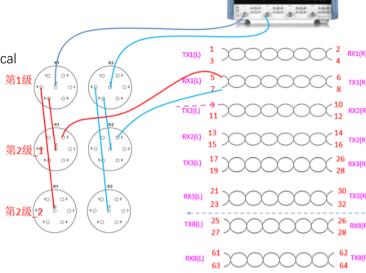


37 | Sorting Machine



Switch Matrix Feature

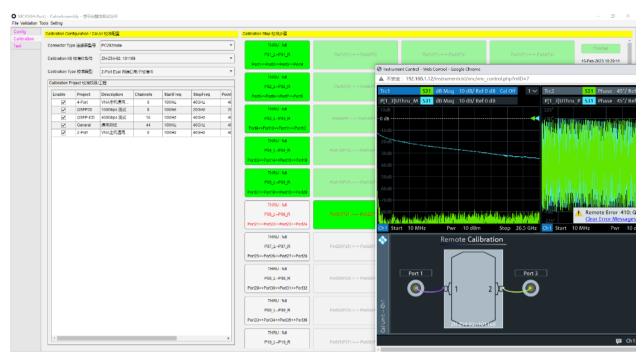
- Up to 64 ports measurement
- Up to 96/128/144 channels expansion
- Frequency range: DC~40GHz
- Life span: Over 2 million cycles
- Supports electronic calibration kits/mechanical calibration kits
- Remote control: RS485, USB



Testing Capabilities

Product Model	STP8000L		
Frequency-domain Test	Insertion Loss SDD21/ILV		
	Return Loss SDD11 SDD22		
	Common-Differential Return Loss SDC11 SDC22 SCD11 SCD22		
	Common-Common Return Loss SCC11 SCC22		
	Common-Differential Insertion Loss SCD21 SDC21		
	SNR SCD21-SDD21		
	Crosstalk: FEXT NEXT / MDFEXT/MDNEXT/PSFEXT/PSNEXT		
Time-domain Test	Differential Impedance TDD11 TDD22		
	Intra-pair Skew and Differential Signal Pairs Skew		
	Differential Delay		
Others	ICR/ICN···		

Fully Automated Calibration, Testing, and Result Display

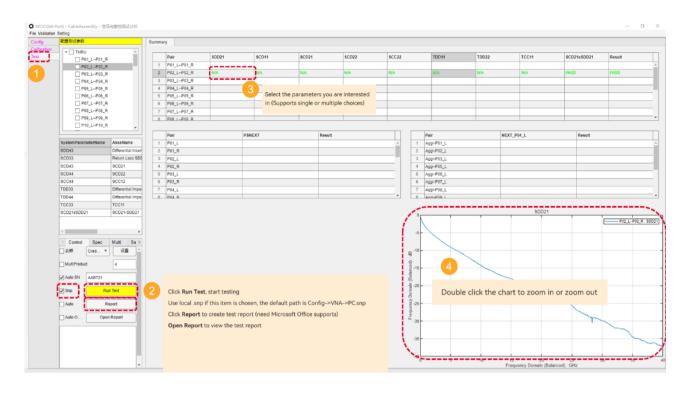


Calibration



Testing





Test Results

Advanced Calibration Technology

- Calibration Method: Electronic Calibration Kit/Mechanical Calibration Kit
- Straight-through Test Calibration: Calibrate corresponding straight-through, calibrate according to the number of channels
- Crosstalk Calibration: Calibrate straight-through and use de-embedding or other methods for de-embedding
- Calibration Accuracy: When testing straight-through parts within 40GHz, insertion loss deviation is less than ± 0.2 dB, and return loss is less than -27dB
- Supports AFR de-embedding: Requires integration of AFR de-embedding function in the test software, supports batch testing of straight-through de-embedding.
- Supports independent de-embedding for each channel
- Selectable de-embedding options include insertion loss de-embedding, crosstalk deembedding, no de-embedding for return loss, and no de-embedding for impedance.

Order Information

Number	Item	Quantity	Description
1	Mvit_Switch_platform Switch Matrix	1	Loaded switch matrix with 64 channels, expandable to 96/128/144 channels.
2	STP8000L Testing Software	1	Testing software -PCle Gen4/Gen5 1X / 2X / 4X / 8X -Mini SAS HD / Slimline SAS -SFP / SFP+ / SFP28 / SFP56 -QSFP+/QSFP28/QSFP56/QSFP-DD/uQSFP/ OSFP Test
3	Cables	Several	Stable amplitude and phase testing cables, connecting switches and products under test
4	Barcode Scanner	1	Automatically load product information and configuration for testing
5	Computer and Label Printer	1	Reference configuration: Intel i5 11400F processor, 16G memory, 256G hard disk, multiple USB3.0 interfaces, dual network cards. The printer can print labels of various sizes and different colors and fonts.